IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application.

1-18 (Canceled)

19. (Withdrawn) A method of manufacturing a display device, comprising:

forming at least one concave portion in a front surface of a second substrate;

bonding a first substrate and the second substrate; and

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

20. (Withdrawn) A method of manufacturing a display device according to claim 19 further comprising: forming a scribe line in a front surface of the first substrate, and

making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.

21. (Withdrawn) A method of manufacturing a display device according to claim 19 further comprising: forming a scribe line in a rear surface of the first substrate, and

making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.

22. (Withdrawn) A method of manufacturing a display device according to claim 19,

wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate.

23. (Currently amended) A method of manufacturing a display device[[,]] comprising: [[a step of]]

forming a thin film transistor over a first substrate;

forming a pixel electrode over the first substrate, wherein the pixel electrode is electrically connected to the thin film transistor; and

bonding [[a]] the first substrate and a second substrate ~~in which at least one concave portion is formed~~ through a seal pattern, wherein at least one concave portion is formed in the second substrate,

wherein at least one of the first substrate and the second substrate has a light transmittance property,

wherein a step of hardening the seal pattern is performed in [[a]] an arrangement in which the first substrate is at an upper side and the second substrate is at a lower side, and

wherein at least a portion of the seal pattern is located in the concave portion of the second substrate after bonding the first substrate and the second substrate.

24. (Currently amended) A method of manufacturing a display device according to claim 23, further comprising a light emitting layer comprising an organic material over the pixel electrode ~~wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate~~.

25. (Withdrawn) A method of manufacturing a display device, comprising:

preparing a second substrate having at least one concave portion;

bonding a first substrate and the second substrate; and

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

26. (Withdrawn) A method of manufacturing a display device according to claim 25 further comprising:

forming a scribe line in a front surface of the first substrate, and

making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.

27. (Withdrawn) A method of manufacturing a display device according to claim 25 further comprising:

forming a scribe line in a rear surface of the first substrate, and

making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.

28. (Withdrawn) A method of manufacturing a display device according to claim 25, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate.

29. (Currently amended) A method of manufacturing a display device, comprising:

forming a light emitting element over a first substrate, said light emitting element comprising an anode, an light emitting layer comprising an organic material, and a cathode;

forming at least one concave portion in a front surface of a second substrate; and

bonding [[a]] the first substrate and the second substrate through a sealing material;

wherein the first substrate has a light transmittance property,

wherein the sealing material fills the concave portion of the second substrate, and

wherein a drying agent is provided between the first substrate and the second substrate.

30. (Withdrawn) A method of manufacturing a display device according to claim 29 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

31. (Canceled)

32. (Currently amended) A method of manufacturing a display device, comprising:

forming a thin film transistor over a first substrate;

forming a pixel electrode over the first substrate, wherein the pixel electrode is electrically connected to the thin film transistor;

preparing a second substrate having at least one concave portion; and

bonding [[a]] the first substrate and the second substrate through a sealing

material;

wherein at least one of the first substrate and the second substrate has a light transmittance property, and

wherein the sealing material fills the concave portion of the second substrate.

33. (Withdrawn) A method of manufacturing a display device according to claim 32 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

34. (Currently amended) A method of manufacturing a display device according to claim 32, further comprising a light emitting layer comprising an organic material over the pixel electrode ~~wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate~~.

35. (Withdrawn) A method of manufacturing a display device, comprising:

forming a scribe line in a rear surface of the first substrate;

forming at least one concave portion in a front surface of a second substrate; and

bonding the first substrate and the second substrate through a sealing material;

wherein the sealing material fills the concave portion of the second substrate.

36. (Withdrawn) A method of manufacturing a display device according to claim 35 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

37. (Withdrawn) A method of manufacturing a display device according to claim 35, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate.

38. (Withdrawn) A method of manufacturing a display device, comprising:

preparing a first substrate having a scribe line and a second substrate having at least one concave portion; and

bonding the first substrate and the second substrate through a sealing material; and

wherein the sealing material fills the concave portion of the second substrate.

39. (Withdrawn) A method of manufacturing a display device according to claim 38 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

40. (Withdrawn) A method of manufacturing a display device according to claim 38, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate.

41. (New) A method of manufacturing a display device, comprising:

forming a light emitting element over a first substrate, said light emitting element comprising an anode, an light emitting layer comprising an organic material, and a cathode; and

bonding the first substrate and a second substrate through a seal pattern, wherein at least one concave portion is formed in the second substrate;

wherein at least one of the first substrate and the second substrate has a light transmittance property,

wherein a step of hardening the seal pattern is performed in an arrangement in which the first substrate is at an upper side and the second substrate is at a lower side, and

wherein at least a portion of the seal pattern is located in the concave portion of the second substrate after bonding the first substrate and the second substrate.

42. (New) A method of manufacturing a display device, comprising:

forming a light emitting element over a first substrate, said light emitting element comprising an anode, a light emitting layer comprising an organic material, and a cathode;

preparing a second substrate having at least one concave portion; and

bonding the first substrate and the second substrate through a sealing material;

wherein at least one of the first substrate and the second substrate has a light transmittance property, and

wherein the sealing material fills the concave portion of the second substrate.

43. (New) A method of manufacturing a display device, comprising:

forming a light emitting element over a first substrate, said light emitting element comprising an anode, a light emitting layer comprising an organic material, and a cathode;

preparing a second substrate having at least one concave portion; and

bonding the first substrate and the second substrate through a sealing material;

wherein the first substrate has a light transmittance property,

wherein the sealing material fills the concave portion of the second substrate, and

wherein a drying agent is provided between the first substrate and the second substrate.

44. (New) A method of manufacturing a display device according to claim 29, wherein the second substrate has a second concave portion, and

wherein the drying agent is provided in the second concave portion.

45. (New) A method of manufacturing a display device according to claim 43, wherein the second substrate has a second concave portion, and

wherein the drying agent is provided in the second concave portion.

46. (New) A method of manufacturing a display device according to claim 23, wherein the seal pattern comprises an organic material.

47. (New) A method of manufacturing a display device according to claim 29, wherein the sealing material comprises an organic material.

48. (New) A method of manufacturing a display device according to claim 32, wherein the sealing material comprises an organic material.

49. (New) A method of manufacturing a display device according to claim 41, wherein the seal pattern comprises an organic material.

50. (New) A method of manufacturing a display device according to claim 42, wherein the sealing material comprises an organic material.

51. (New) A method of manufacturing a display device according to claim 43, wherein the sealing material comprises an organic material.